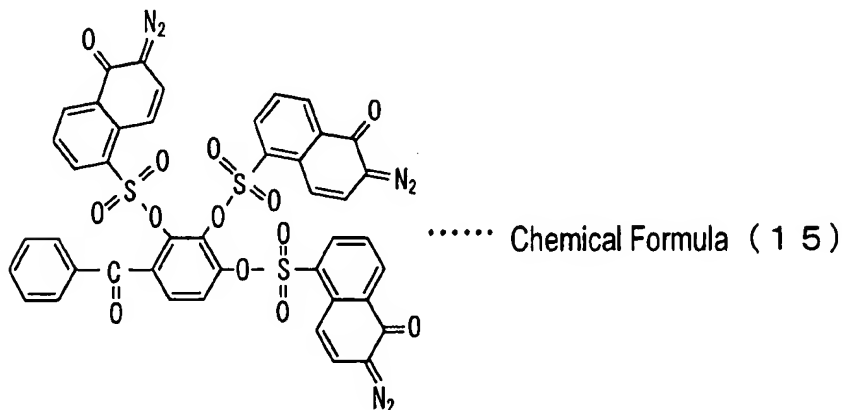


4. The resin composition of claim ³ wherein the o-quinone diazide compound is 2,3,4-trihydroxybenzophenone o-naphthoquinone diazide sulfonic ester represented by chemical formula (15) below:



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5. A process for forming a resin film comprising the steps of coating an object on which a resin film is to be formed with a resin composition containing a polyimide precursor having a polymer structure unit represented by formula (1) below and having an imidization degree of 7.5 % or more and 36 % or less and a photosensitizer to form a resin film, exposing the resin film to light to form a latent image, developing the resin film and heating